

Digital Power Monitor with Convert Pin and ALERTB Output

Data Sheet **ADM1191**

FEATURES

Powered from 3.15 V to 26 V Precision current sense amplifier Precision voltage input 12-bit ADC for current and voltage readback Convert (CONV) pin for commanding an ADC read SETV input for setting overcurrent alert threshold ALERTB output provides an overcurrent interrupt I 2C fast mode-compliant interface (400 kHz maximum) 2 address pins allow 16 devices on the same bus 10-lead MSOP

APPLICATIONS

Power monitoring/power budgeting Central office equipment Telecommunications and data communications equipment PCs/servers

GENERAL DESCRIPTION

The ADM1191 is an integrated current sense amplifier that offers digital current and voltage monitoring via an on-chip 12-bit analog-to-digital converter (ADC), communicated through an I^2C^* interface.

An internal current sense amplifier measures voltage across the sense resistor in the power path via the VCC pin and the SENSE pin.

A 12-bit ADC can measure the current seen in the sense resistor, as well as the supply voltage on the VCC pin.

An industry-standard I 2 C interface allows a controller to read current and voltage data from the ADC. Measurements can be initiated by an I 2 C command or via the convert (CONV) pin. The CONV pin is especially useful for synchronizing reads on multiple ADM1191 devices. Alternatively, the ADC can run continuously, and the user can read the latest conversion data whenever it is required. Up to 16 unique I²C addresses can be created, depending on the way the A0 pin and the A1 pin are connected.

A SETV pin is also included. A voltage applied to this pin is internally compared with the output voltage on the current sense amplifier. The output of the SETV comparator asserts when the current sense amplifier output exceeds the SETV voltage. When this event occurs, the ALERTB output asserts.

FUNCTIONAL BLOCK DIAGRAM

The ALERTB output can be used as a flag to warn a microcontroller or field programmable gate array (FPGA) of an overcurrent condition. ALERTB outputs of multiple ADM1191 devices can be tied together and used as a combined alert.

The ADM1191 is packaged in a 10-lead MSOP.

Rev. C

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User Guides

• UG-404: USB-SDP-CABLEZ Serial Interface Board

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- ADMxxxx Common Run-Time

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REVISION HISTORY

6/12—Rev. B to Rev. C

2/08—Rev. A to Rev. B

4/07—Rev. 0 to Rev. A

9/06—Revision 0: Initial Version

SPECIFICATIONS

V_{CC} = 3.15 V to 26 V, T_A = −40°C to +85°C, typical values at T_A = 25°C, unless otherwise noted.

Table 1.

¹ Monitoring accuracy is a measure of the error in a code that is read back for a particular voltage/current. This is a combination of amplifier error, reference error, ADC error, and error in ADC full-scale code conversion factor.

 2 This is an absolute value to be used when converting ADC codes to current readings; any inaccuracy in this value is factored into absolute current accuracy values (see the specifications for the Current Sense Absolute Accuracy parameter).

 3 These are absolute values to be used when converting ADC codes to voltage readings; any inaccuracy in these values is factored into voltage accuracy values (see the $\,$ specifications for the Voltage Sense Accuracy parameter).

⁴ Time between the receipt of the command byte and the actual ADC result being placed in the register.

ABSOLUTE MAXIMUM RATINGS

Table 2.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL CHARACTERISTICS

 θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 3. Thermal Resistance

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Figure 3. Pin Configuration

Table 4. Pin Function Descriptions

TYPICAL PERFORMANCE CHARACTERISTICS

Figure 6. Address Pin Voltage vs. Address Pin Current for Four Addressing Options on Each Address Pin

Figure 7. ADC Noise with Current Channel, Midcode Input, and 1000 Reads

Figure 8. ADC Noise with 14:1 Voltage Channel, 5 V Input, and 1000 Reads

Figure 9. ADC Noise with 7:1 Voltage Channel, 5 V Input, and 1000 Reads

VOLTAGE AND CURRENT READBACK

The ADM1191 contains the components to allow voltage and current readback over an I 2 C bus. The voltage output of the current sense amplifier and the voltage on the VCC pin are fed into a 12-bit ADC via a multiplexer. The device can be instructed to convert voltage and/or current at any time during operation by issuing an I 2 C command or driving the CONV pin high. When all conversions are complete, the voltage and/or current values can be read back with 12-bit accuracy in two or three bytes.

SERIAL BUS INTERFACE

Control of the ADM1191 is carried out via the serial system management bus (I^2C). This interface is compatible with the I^2C fast mode (400 kHz maximum). The ADM1191 is connected to this bus as a slave device, under the control of a master device.

IDENTIFYING THE ADM1191 ON THE I 2 C BUS

The ADM1191 has a 7-bit serial bus slave address. When the device powers up, it does so with a default serial bus address. The three MSBs of the address are set to 011; the four LSBs are determined by the state of the A0 pin and the A1 pin. There are 16 configurations available on the A0 pin and A1 pin that correspond to 16 I 2 C addresses for the four LSBs (see Table 5). This scheme allows 16 ADM1191 devices to operate on a single I²C bus.

GENERAL I 2 C TIMING

Figure 16 and Figure 17 show timing diagrams for general write and read operations using the I²C. The I²C specification defines conditions for different types of read and write operations, which are discussed in the Write and Read Operations section. The general I 2 C protocol operates as follows:

1. The master initiates a data transfer by establishing a start condition, defined as a high-to-low transition on the serial data line, SDA, while the serial clock line, SCL, remains high. This indicates that a data stream is to follow. All slave peripherals connected to the serial bus respond to the start condition and shift in the next eight bits, consisting of a 7-bit slave address (MSB first) plus an R/\overline{W} bit that determines the direction of the data transfer, that is, whether data is written to or read from the slave device $(0 = \text{write}, 1 = \text{read})$.

The peripheral whose address corresponds to the transmitted address responds by pulling the data line low during the low period before the ninth clock pulse, known as the acknowledge bit, and holding it low during the high period of this clock pulse. All other devices on the bus remain idle while the selected device waits for data to be read from it or written to it. If the R/\overline{W} bit is 0, the master writes to the slave device. If the R/\overline{W} bit is 1, the master reads from the slave device.

2. Data is sent over the serial bus in sequences of nine clock pulses: eight bits of data followed by an acknowledge bit from the slave device. Data transitions on the data line must occur during the low period of the clock signal and remain stable during the high period because a low-tohigh transition when the clock is high can be interpreted as a stop signal.

If the operation is a write operation, the first data byte after the slave address is a command byte. This tells the slave device what to expect next. It can be an instruction, such as telling the slave device to expect a block write, or it can be a register address that tells the slave where subsequent data is to be written.

Because data can flow in only one direction, as defined by the R/W bit, it is not possible to send a command to a slave device during a read operation. Before performing a read operation, it may be necessary to first execute a write operation to tell the slave what sort of read operation to expect and/or the address from which data is to be read.

3. When all data bytes are read or written, stop conditions are established. In write mode, the master pulls the data line high during the $10th$ clock pulse to assert a stop condition. In read mode, the master device releases the SDA line during the SCL low period before the ninth clock pulse, but the slave device does not pull it low. This is known as a no acknowledge. The master then takes the data line low during the SCL low period before the $10th$ clock pulse and then high during the 10th clock pulse to assert a stop condition.

Base Address	A1 Pin State	A0 Pin State	A1 Pin Logic State	A0 Pin Logic State	Address in Binary ¹	Address in Hex
011	Ground	Ground	00	00	0110000X	0x60
	Ground	Resistor to ground	00	01	0110001X	0x62
	Ground	Floating	00	10	0110010X	0x64
	Ground	High	00	11	0110011X	0x66
	Resistor to ground	Ground	01	00	0110100X	0x68
	Resistor to ground	Resistor to ground	01	01	0110101X	0x6A
	Resistor to ground	Floating	01	10	0110110X	0x6C
	Resistor to ground	High	01	11	0110111X	0x6E
	Floating	Ground	10	00	0111000X	0x70
	Floating	Resistor to ground	10	01	0111001X	0x72

Table 5. Setting I2 C Addresses via the A0 Pin and the A1 Pin

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 $1 X =$ don't care.

Figure 17. General I 2 C Read Timing Diagram

Figure 18. Serial Bus Timing Diagram

WRITE AND READ OPERATIONS

The I 2 C specification defines several protocols for different types of read and write operations. The operations used in the ADM1191 are discussed in this section. Table 6 shows the abbreviations used in the command diagrams (see Figure 19 to Figure 24).

Table 6. I2 C Abbreviations

QUICK COMMAND

The quick command operation allows the master to check if the slave is present on the bus, as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address, followed by the write bit (low).
- 3. The addressed slave device asserts an acknowledge on SDA.
- 4. The master asserts a stop condition on SDA to end the transaction.

Figure 19. Quick Command

Table 7. Command Byte Operations

WRITE COMMAND BYTE

In the write command byte operation, the master device sends a command byte to the slave device, as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address, followed by the write bit (low).
- 3. The addressed slave device asserts an acknowledge on SDA.
- 4. The master sends the command byte. The command byte is identified by an $MSB = 0$. An $MSB = 1$ indicates an extended register write (see the Write Extended Command Byte section).
- 5. The slave asserts an acknowledge on SDA.
- 6. The master asserts a stop condition on SDA to end the transaction.

Figure 20. Write Command Byte

The seven LSBs of the command byte are used to configure and control the ADM1191. Table 7 provides details of the function of each bit.

WRITE EXTENDED COMMAND BYTE

In the write extended command byte operation, the master device writes to one of the three extended registers of the slave device, as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address, followed by the write bit (low).
- 3. The addressed slave device asserts an acknowledge on SDA.
- 4. The master sends the register address byte. The MSB of this byte is set to 1 to indicate an extended register write. The two LSBs indicate which of the three extended registers is to be written to (see Table 8). All other bits should be set to 0.
- 5. The slave asserts an acknowledge on SDA.
- 6. The master sends the extended command byte (refer to Table 9, Table 10, and Table 11).
- 7. The slave asserts an acknowledge on SDA.
- 8. The master asserts a stop condition on SDA to end the transaction.

Figure 21. Write Extended Byte

Table 9, Table 10, and Table 11 provide the details of each extended register.

Table 8. Extended Register Addresses

Table 9. ALERT_EN Register Operations

Table 10. ALERT_TH Register Operations

Table 11. CONTROL Register Operations

READ VOLTAGE AND/OR CURRENT DATA BYTES

Depending on how the device is configured, ADM1191 can be set up to provide information in three ways after a conversion (or conversions): voltage and current readback, voltage only readback, and current only readback. See the Write Command Byte section for more details.

Voltage and Current Readback

The ADM1191 digitizes both voltage and current. Three bytes are read back in the format shown in Table 12.

Voltage Readback

The ADM1191 digitizes voltage only. Two bytes are read back in the format shown in Table 13.

Current Readback

The ADM1191 digitizes current only. Two bytes are read back in the format shown in Table 14.

The following series of events occurs when the master receives three bytes (voltage and current data) from the slave device:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address, followed by the read bit (high).
- 3. The addressed slave device asserts an acknowledge on SDA.
- 4. The master receives the first data byte.
- 5. The master asserts an acknowledge on SDA.
- 6. The master receives the second data byte.
- 7. The master asserts an acknowledge on SDA.
- 8. The master receives the third data byte.
- 9. The master asserts a no acknowledge on SDA.
- 10. The master asserts a stop condition on SDA, and the transaction ends.

For cases where the master is reading voltage only or current only, two data bytes are read and Step 7 and Step 8 are not required.

Figure 23. Two-Byte Read from ADM1191

Converting ADC Codes to Voltage and Current Readings

Equation 1 and Equation 2 can be used to convert ADC codes representing voltage and current from the ADM1191 12-bit ADC into actual voltage and current values.

$$
Voltage = (V_{FULISCALE}/4096) \times Code \tag{1}
$$

where:

V_{FULLSCALE} = 6.65 *V* (7:2 range) or 26.52 *V* (14:1 range). *Code* is the ADC voltage code read from the device (Bit V11 to Bit V0).

Current = ((*IFULLSCALE*/4096) × *Code*)/*Sense Resistor* (2)

where:

 $I_{FUIISCAIF} = 105.84$ mV. *Code* is the ADC current code read from the device (Bit I11 to Bit I0).

Read Status Register

A single register of status data can also be read from the ADM1191 as follows:

- 1. The master device asserts a start condition on SDA.
- 2. The master sends the 7-bit slave address, followed by the read bit (high).
- 3. The addressed slave device asserts an acknowledge on SDA.
- 4. The master receives the status byte.
- 5. The master asserts an acknowledge on SDA.

Figure 24. Status Read from ADM1191

Table 15 shows the ADM1191 STATUS registers in detail. Note that Bit 1, Bit 3, and Bit 5 are cleared by writing to Bit 4 (the CLEAR bit) of the ALERT_EN register.

Table 15. Status Byte Operations

APPLICATIONS INFORMATION **ALERTB OUTPUT**

The ALERTB output is an open-drain pin with 30 V tolerance. This output can be used as an overcurrent flag by connecting it to the general-purpose logic input of a controller. During normal operation, this output is pulled high (an external pull-up resistor should be used because this is an open-drain pin). When an overcurrent condition occurs, the ADM1191 pulls this output low. The ALERTB pin is disabled by default on power up. See the ALERT_EN register to enable.

SETV PIN

The SETV pin allows the user to adjust the current level that trips the ALERTB output. The output of the current sense amplifier is compared with the voltage driven onto the SETV pin. If the current sense amplifier output is higher than the SETV voltage, the output of the comparator asserts. By driving a different voltage onto the SETV pin, the ADM1191 detects an overcurrent

condition at a different current level, with a gain of 18. See Figure 12 for an illustration of this relationship.

KELVIN SENSE RESISTOR CONNECTION

When using a low value sense resistor for high current measurement, the problem of parasitic series resistance can arise. The pad and solder resistance can be a substantial fraction of the rated resistance, making the total resistance larger than expected. This error problem can be largely avoided by using a Kelvin sense connection. This type of connection separates the high current path through the resistor and the voltage drop across the resistor. A 4-pad resistor may be used or a split pad layout can be used with a 2-pad sense resistor to achieve Kelvin sensing.

OUTLINE DIMENSIONS

Dimensions shown in millimeters

ORDERING GUIDE

¹ Z = RoHS Compliant Part.

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